

# **MC10LVEP11DTR2G Datasheet**

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 DiGi Electronics Part Number
 MC10LVEP11DTR2G-DG

 Manufacturer
 onsemi

 Manufacturer Product Number
 MC10LVEP11DTR2G

 Description
 IC CLK BUFFER 1:2 3GHZ 8TSSOP

 Detailed Description
 Clock Fanout Buffer (Distribution) IC 1:2 3 GHZ 8-TS SOP, 8-MSOP (0.118", 3.00mm Width)

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MC10LVEP11DTR2G	onsemi
Series:	Product Status:
	Obsolete
Туре:	Number of Circuits:
Fanout Buffer (Distribution)	1
Ratio - Input:Output:	Differential - Input:Output:
1:2	Yes/Yes
Input:	Output:
CML, LVDS, PECL	ECL, PECL
Frequency - Max:	Voltage - Supply:
3 GHz	2.375V ~ 3.8V
Operating Temperature:	Mounting Type:
-40°C ~ 85°C	Surface Mount
Package / Case:	Supplier Device Package:
8-TSSOP, 8-MSOP (0.118", 3.00mm Width)	8-TSSOP
Base Product Number:	
MC10LV	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	3 (168 Hours)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

# **NSEM**I.

# 2.5 V/3.3 V ECL 1:2 **Differential Fanout Buffer** MC10LVEP11, MC100LVEP11

#### Description

The MC10/100LVEP11 is a differential 1:2 fanout buffer. The device is pin and functionally equivalent to the EP11 device. With AC performance the same as the EP11 device, the LVEP11 is ideal for applications requiring lower voltage. Single-ended CLK input operation is limited to a  $V_{CC} \ge 3.0$  V in PECL mode, or  $V_{EE} \le$ -3.0 V in NECL mode.

The 100 Series contains temperature compensation.

#### Features

- 240 ps Typical Propagation Delay
- Maximum Frequency > 3.0 GHz Typical
- PECL Mode Operating Range:
  - $V_{CC} = 2.375$  V to 3.8 V with  $V_{EE} = 0$  V
- NECL Mode Operating Range:
- $V_{CC} = 0$  V with  $V_{EE} = -2.375$  V to -3.8 V
- Open Input Default State
- Q Output Will Default LOW with Inputs Open or at V<sub>EE</sub>
- LVDS Input Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

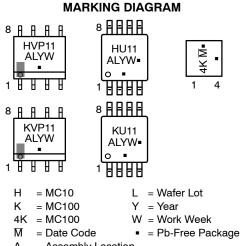




SOIC-8 NB D SUFFIX CASE 751-07

DFN<sub>-8</sub> DT SUFFIX **MN SUFFIX** CASE 948R-02

CASE 506AA



TSSOP-8

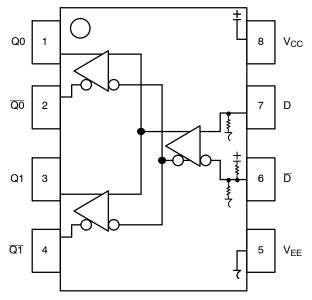
= Assembly Location

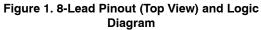
(Note: Microdot may be in either location) \*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC10LVEP11DR2G	SOIC-8 NB (Pb-Free)	2500 / Tape & Reel
MC10LVEP11DTG	TSSOP-8 (Pb-Free)	100 Units / Tube
MC100LVEP11DG	SOIC-8 NB (Pb-Free)	98 Units / Tube
MC100LVEP11DR2G	SOIC-8 NB (Pb-Free)	2500 / Tape & Reel
MC100LVEP11DTG	TSSOP-8 (Pb-Free)	100 Units / Tube
MC100LVEP11DTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel
MC100LVEP11MNR4G	DFN–8 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





#### Table 1. PIN DESCRIPTION

PIN	FUNCTION
D*, <u>D</u> **	ECL Data Inputs
Q0, <u>Q0</u> , Q1, <u>Q1</u>	ECL Data Outputs
V <sub>CC</sub>	Positive Supply
V <sub>EE</sub>	Negative Supply
EP	(DFN–8 only) Thermal exposed pad must be connected to a sufficient ther- mal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open.

\*Pins will default to 2/3  $V_{CC}$  when left open. \*\*Pins will default LOW when left open.

#### Table 2. ATTRIBUTES

Characteristics	Value
Internal Input Pulldown Resistor	75 kΩ
Internal Input Pullup Resistor	37.5 kΩ
ESD Protection Human Body Model Machine Model Charged Device Model	> 4 kV > 200 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Pb-Free Pkg
SOIC–8 NB TSSOP–8 DFN–8	Level 1 Level 3 Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in
Transistor Count	110 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	I

1. For additional information, see Application Note AND8003/D.

#### Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		6	V
$V_{EE}$	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	V <sub>I</sub> ≤[V <sub>CC</sub> V <sub>I</sub> ≥[V <sub>EE</sub>	6 -6	V
I <sub>out</sub>	Output Current	Continuous Surge		50 100	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-8 NB	190 130	°C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-8 NB	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-8	185 140	°C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	DFN-8	129 84	°C/W
θJC	Thermal Resistance (Junction-to-Case)	(Note 1)	DFN-8	35 to 40	°C/W
T <sub>sol</sub>	Wave Solder (Pb-Free)	<2 to 3 sec @ 260°C		265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. JEDEC standard multilayer board – 2S2P (2 signal, 2 power).

#### -40°C 25°C 85°C Symbol Characteristic Min Тур Max Min Тур Max Min Тур Max Unit IEE Power Supply Current 25 33 40 29 33 40 32 34 42 mΑ Output HIGH Voltage (Note 2) 1365 1490 1615 1430 1555 1680 1490 1615 1740 mV VOH Output LOW Voltage (Note 2) 565 740 865 630 805 930 690 865 990 mV VOL Input HIGH Voltage Common Mode Range (Differential Configuration) 1.2 2.5 1.2 2.5 1.2 2.5 V VIHCMR (Note 3) μA Input HIGH Current 150 150 150 lιΗ $\mathsf{I}_{\mathsf{IL}}$ Input LOW Current μA 0.5 0.5 0.5 D D -150 -150 -150

#### Table 4. 10LVEP DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 2.5 V, V<sub>EE</sub> = 0 V (Note 1))

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.125 V to -1.3 V.

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal. Single-Ended input CLK pin operation is limited to V<sub>CC</sub> ≥[3.0 V in PECL mode.

		<b>−40°C</b>			25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Мах	Unit
I <sub>EE</sub>	Power Supply Current	25	33	40	29	33	40	32	34	42	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	2165	2290	2415	2230	2355	2480	2290	2415	2540	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	1365	1540	1665	1430	1605	1730	1490	1665	1790	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 3)	2090		2415	2155		2480	2215		2540	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 3)	1365		1690	1430		1755	1490		1815	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	1.2		3.3	1.2		3.3	1.2		3.3	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
Ι <sub>ΙL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.925 V to -0.5 V.

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

3. Single-Ended input CLK pin operation is limited to V<sub>CC</sub> ≥3.0 V in PECL mode.

4. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

#### Table 6. 10LVEP DC CHARACTERISTICS, NECL ( $V_{CC} = 0 V$ , $V_{EE} = -3.8 V$ to -2.375 V (Note 1))

			<b>−40°C</b>			25°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	25	33	40	29	33	40	32	34	42	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	-1135	-1010	-885	-1070	-945	-820	-1010	-885	-760	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	-1935	-1760	-1635	-1870	-1695	-1570	-1810	-1635	-1510	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 3)	-1210		-885	-1145		-820	-1085		-760	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 3)	-1935		-1610	-1870		-1545	-1810		-1485	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	V <sub>EE</sub>	+1.2	0.0	V <sub>EE</sub>	+1.2	0.0	V <sub>EE</sub>	V <sub>EE</sub> +1.2		V
Ι <sub>ΙΗ</sub>	Input HIGH Current			150			150			150	μΑ
Ι <sub>ΙL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

3. Single-Ended input CLK pin operation is limited to V<sub>EE</sub> ≤<sub>B</sub>-3.0 V in NECL mode.

4. V<sub>IHCMR</sub> min varies 1:1 with V<sub>E</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	25	35	42	29	38	46	32	41	50	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	1355	1480	1605	1355	1480	1605	1355	1480	1605	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	555	730	900	555	730	900	555	730	900	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	1335		1620	1335		1620	1335		1620	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	555		900	555		900	555		900	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3)	1.2		2.5	1.2		2.5	1.2		2.5	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
Ι <sub>ΙL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

#### Table 7. 100LVEP DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 2.5 V, V<sub>EE</sub> = 0 V (Note 1))

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.125 V to -1.3 V.

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

3. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal. Single-Ended input CLK pin operation is limited to V<sub>CC</sub> ≥[3.0 V in PECL mode.

#### Table 8. 100LVEP DC CHARACTERISTICS, PECL (V<sub>CC</sub> = 3.3 V, V<sub>EE</sub> = 0 V (Note 1))

		<b>−40°C</b>			25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	25	35	42	29	38	46	32	41	50	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	2155	2280	2405	2155	2280	2405	2155	2280	2405	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	1355	1530	1700	1355	1530	1700	1355	1530	1700	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 3)	2135		2420	2135		2420	2135		2420	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 3)	1355		1700	1355		1700	1355		1700	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	1.2		3.3	1.2		3.3	1.2		3.3	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.925 V to -0.5 V.

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

3. Single-Ended input CLK pin operation is limited to  $V_{CC} \ge 3.0$  V in PECL mode.

4. V<sub>IHCMR</sub> min varies 1:1 with V<sub>E</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

#### Table 9. 100LVEP DC CHARACTERISTICS, NECL ( $V_{CC} = 0 V$ ; $V_{EE} = -3.8 V$ to -2.375 V (Note 1))

			–40°C			25°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	25	35	42	29	38	46	32	41	50	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2)	-1945	-1770	-1600	-1945	-1770	-1600	-1945	-1770	-1600	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 3)	-1165		-880	-1165		-880	-1165		-880	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 3)	-1945	-1425	-1600	-1945	-1425	-1600	-1945	-1425	-1600	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	V <sub>EE</sub>	+1.2	0.0	V <sub>EE</sub>	+1.2	0.0	V <sub>EE</sub>	+1.2	0.0	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Input and output parameters vary 1:1 with  $V_{CC}$ .

2. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

3. Single-Ended input CLK pin operation is limited to V<sub>EE</sub> ≤ -3.0 V in NECL mode.

4. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

			–40°C 25°C			85°C						
				-40 0	1		23 0			05 0		
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Frequency (Figure 2)			3			3			3		GHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay (Differential Configuration) CLK to Q, Q		170	230	300	180	240	310	210	270	360	ps
t <sub>SKEW</sub>	Within Device Skew Device to Device Skew (Note 2)	Q, <u>Q</u>		5.0	20 130		5.0	20 130		5.0	20 150	ps
t <sub>JITTER</sub>	CLOCK Random Jitter (RMS) @ ≤1.0 GHz @ ≤1.5 GHz @ ≤2.0 GHz @ ≤2.5 GHz @ ≤3.0 GHz			0.126 0.112 0.111 0.112 0.155	0.3 0.2 0.3 0.2 0.2		0.142 0.162 0.122 0.172 0.217	0.4 0.3 0.2 0.3 0.3		0.209 0.162 0.170 0.235 0.368	0.3 0.2 0.3 0.3 0.6	ps
V <sub>PP</sub>	Input Voltage Swing (Differential Configuration)		150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times (20% – 80%)	Q,	70	110	170	80	120	180	100	140	200	ps

Table 10. AC CHARACTERISTICS ( $V_{CC} = 0 V$ ;  $V_{EE} = -3.8 V$  to -2.375 V or  $V_{CC} = 2.375 V$  to 3.8 V;  $V_{EE} = 0 V$  (Note 1))

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

1. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50  $\Omega$  to V<sub>CC</sub> – 2.0 V.

2. Skew is measured between outputs under identical transitions.

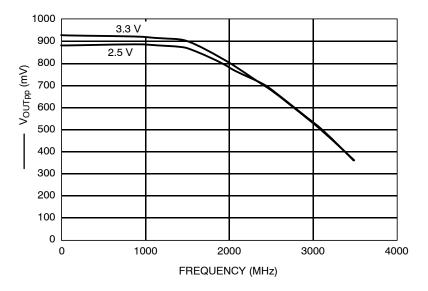
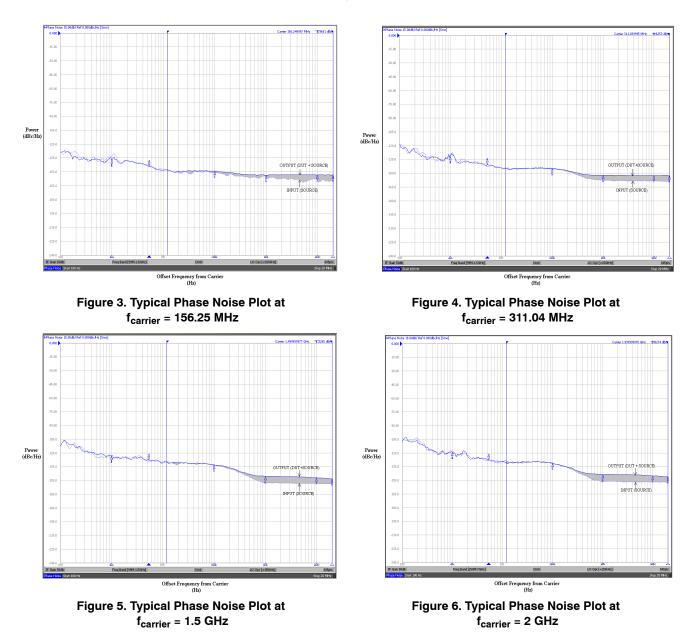


Figure 2. F<sub>max</sub> Typical



The above phase noise plots captured using Agilent E5052A show additive phase noise of the MC100LVEP11 device at frequencies 156.25 MHz, 311.04 MHz, 1.5 GHz and 2 GHz respectively at an operating voltage of 3.3 V in room temperature. The RMS Phase Jitter contributed by the

device (integrated between 12 kHz and 20 MHz; as shown in the shaded region of the plot) at each of the frequencies is 66 fs, 37 fs, 14 fs and 13 fs respectively. The input source used for the phase noise measurements is Agilent E8663B.

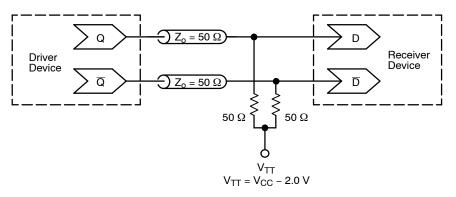


Figure 7. Typical Termination for Output Driver and Device Evaluation (See Application Note <u>AND8020/D</u> – Termination of ECL Logic Devices.)

#### **Resource Reference of Application Notes**

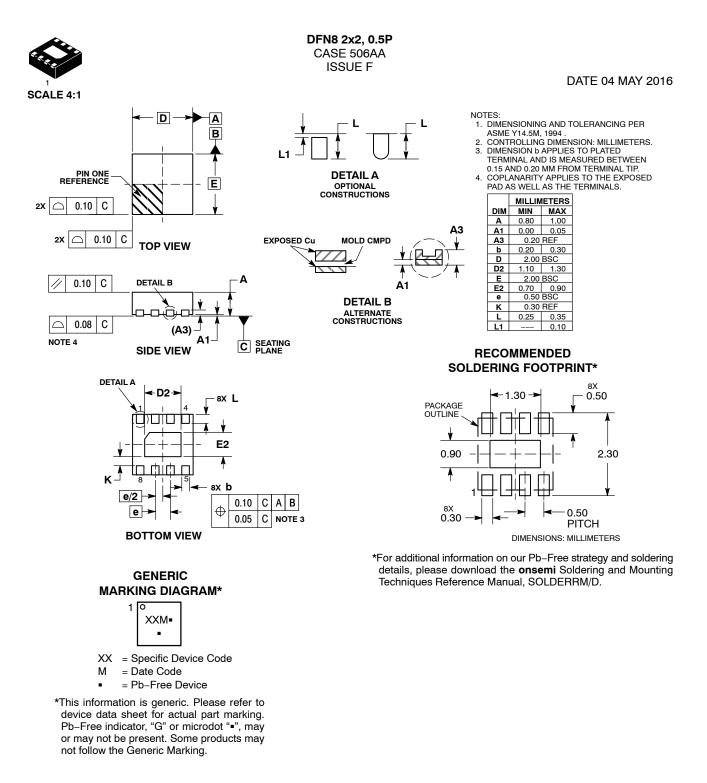
AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	_	ECLinPS <sup>™</sup> I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	-	Interfacing Between LVDS and ECL
AN1672/D	-	The ECL Translator Guide
AND8001/D	-	Odd Number Counters Design
AND8002/D	-	Marking and Date Codes
AND8020/D	-	Termination of ECL Logic Devices
AND8066/D	-	Interfacing with ECLinPS
AND8090/D	-	AC Characteristics of ECL Devices

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# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS

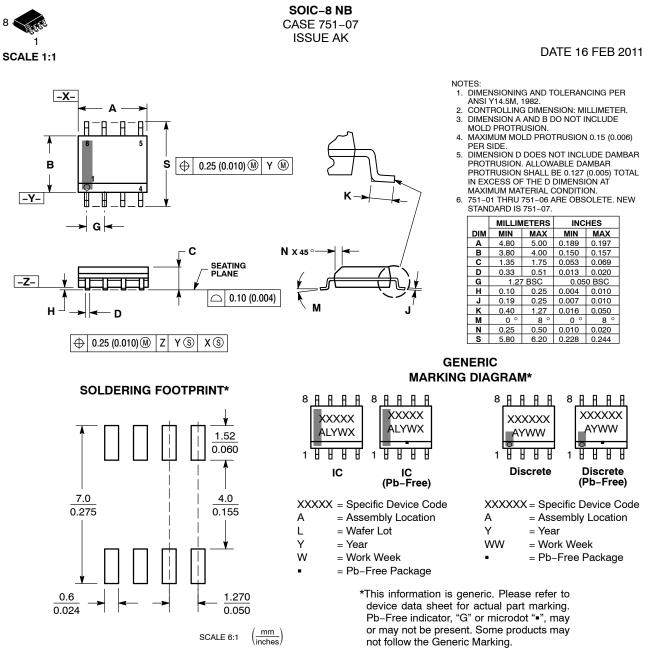


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\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### SOIC-8 NB CASE 751-07 ISSUE AK

STYLE 1: PIN 1. EMITTER COLLECTOR 2. 3. COLLECTOR 4. FMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17 PIN 1. VCC 2. V2OUT V10UT 3. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: CATHODE 1 PIN 1. 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT IOUT 6. IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE P-SOURCE 3 P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18 PIN 1. ANODE 2. ANODE SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8 VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: DRAIN, DIE #1 PIN 1. DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS З. THIRD STAGE SOURCE GROUND 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. З. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. MIRROR 1 STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT OVI O 2 З. UVLO 4. INPUT+ 5. SOURCE SOURCE 6. SOURCE 7. 8 DRAIN

#### STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 З. BASE #2 COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: 11. SW\_TO\_GND 2. DASIC OFF PIN 1. DASIC\_SW\_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK

8 VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

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7.

8

COLLECTOR, #1

COLLECTOR, #1



-T- SEATING

PLANE

D

MECHANICAL CASE OUTLINE

NOTES:

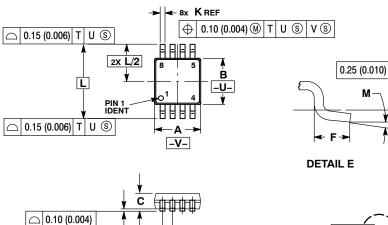
4.

PACKAGE DIMENSIONS



TSSOP-8 3.00x3.00x0.95 CASE 948R-02 ISSUE A

DATE 07 APR 2000



 
 PER SIDE.

 5.
 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

 6.
 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

 MILLIMETERS
 INCHES

 DIM
 MIN
 MAX

 A
 2.90
 3.10
 0.114
 0.122

 B
 2.90
 3.10
 0.114
 0.122

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.

 DIMENSION A DOES NOT INCLUDE MOLD FLASH.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION. SHALL NOT EXCEED 0.25 (0.010)

	DETAIL E-
G	Æ
þ	

	- <b>W</b> -	
TS'		

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С	0.80	1.10	0.031	0.043	
D	0.05	0.15	0.002	0.006	
F	0.40	0.70	0.016	0.028	
G	0.65	0.65 BSC		BSC	
K	0.25	0.40	0.010	0.016	
L	4.90	4.90 BSC		BSC	
М	0°	6 °	0°	6 °	

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